

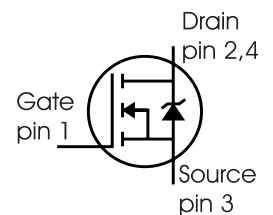
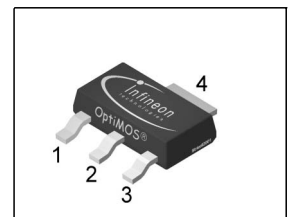
OptiMOS® Power-Transistor
Feature

- N-Channel
- Enhancement mode
- Logic Level
- Green Product (RoHS Compliant)
- AEC Qualified

Product Summary

V_{DS}	55	V
$R_{DS(on)}$	33	m Ω
I_D	5.2	A

SOT 223



Type	Package	Ordering Code	Marking
BSP603S2L	SOT 223	On Request	2N603L

Maximum Ratings, at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous drain current $T_A=25^\circ\text{C}$ $T_A=70^\circ\text{C}$	I_D	5.2 4.1	A
Pulsed drain current $T_A=25^\circ\text{C}$	$I_{D\text{ puls}}$	21	
Gate source voltage	V_{GS}	± 20	V
Power dissipation $T_A=25^\circ\text{C}$	P_{tot}	1.8	W
Operating and storage temperature IEC climatic category; DIN IEC 68-1	T_j, T_{stg}	-55... +150 55/150/00	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Thermal resistance, junction - soldering point (Pin 4)	R_{thJS}	-	15	20	K/W
Thermal resistance, chip to ambient air: @ min. footprint	R_{thJA}	-	-	120	
@ 6 cm ² cooling area ¹⁾		-	-	70	

Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain-source breakdown voltage $V_{GS}=0V, I_D=1mA$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage, $V_{GS} = V_{DS}$ $I_D=50\mu A$	$V_{GS(th)}$	1.2	1.6	2	
Zero gate voltage drain current $V_{DS}=55V, V_{GS}=0V, T_j=25\text{ °C}$ $V_{DS}=55V, V_{GS}=0V, T_j=150\text{ °C}$	I_{DSS}	-	0.1	1	μA
		-	10	100	
Gate-source leakage current $V_{GS}=20V, V_{DS}=0V$	I_{GSS}	-	10	100	nA
Drain-source on-state resistance $V_{GS}=4.5V, I_D=2.6A$	$R_{DS(on)}$	-	27	40	m Ω
Drain-source on-state resistance $V_{GS}=10V, I_D=2.6A$	$R_{DS(on)}$	-	23	33	

¹⁾Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical without blown air.

Electrical Characteristics

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Dynamic Characteristics

Transconductance	g_{fs}	$V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$, $I_D = 5.2$	8.9	17.8	-	S
Input capacitance	C_{iss}	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1MHz$	-	1034	1390	pF
Output capacitance	C_{oss}		-	244	325	
Reverse transfer capacitance	C_{rss}		-	75	110	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 30V$, $V_{GS} = 4.5V$, $I_D = 5.2A$, $R_G = 5.6\Omega$	-	10.8	16	ns
Rise time	t_r	$V_{DD} = 30V$, $V_{GS} = 4.5V$, $I_D = 5.2mA$, $R_G = 5.6\Omega$	-	16	24	
Turn-off delay time	$t_{d(off)}$		-	28	40	
Fall time	t_f		-	15	23	

Gate Charge Characteristics

Gate to source charge	Q_{gs}	$V_{DD} = 44V$, $I_D = 5.2A$	-	3.5	4.6	nC
Gate to drain charge	Q_{gd}		-	10.6	16	
Gate charge total	Q_g	$V_{DD} = 44V$, $I_D = 5.2A$, $V_{GS} = 0$ to $10V$	-	31	42	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} = 44V$, $I_D = 5.2A$	-	3	-	V

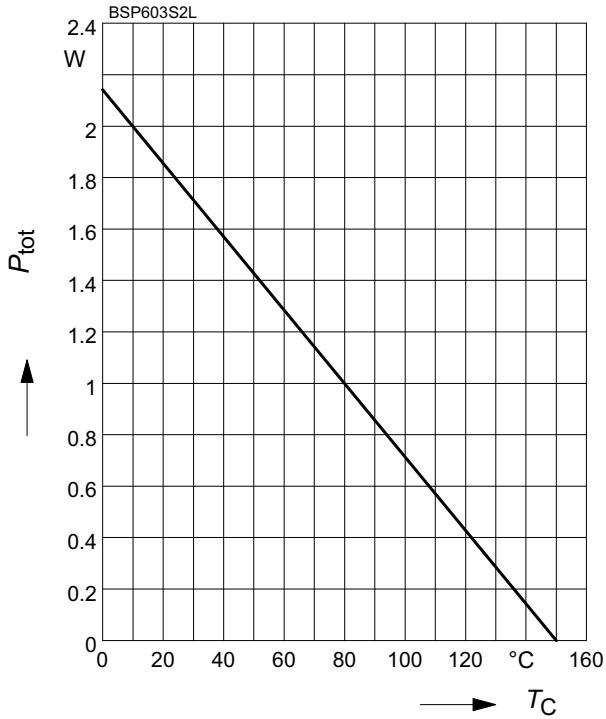
Reverse Diode

Inverse diode continuous forward current	I_S	$T_A = 25^\circ C$	-	-	5.2	A
Inv. diode direct current, pulsed	I_{SM}		-	-	21	
Inverse diode forward voltage	V_{SD}	$V_{GS} = 0V$, $I_F = 5.2A$	-	0.8	1.1	V
Reverse recovery time	t_{rr}	$V_R = 30V$, $I_F = I_S$, $di_F/dt = 100A/\mu s$	-	46	58	ns
Reverse recovery charge	Q_{rr}		-	44	55	nC

1 Power dissipation

$$P_{tot} = f(T_C)$$

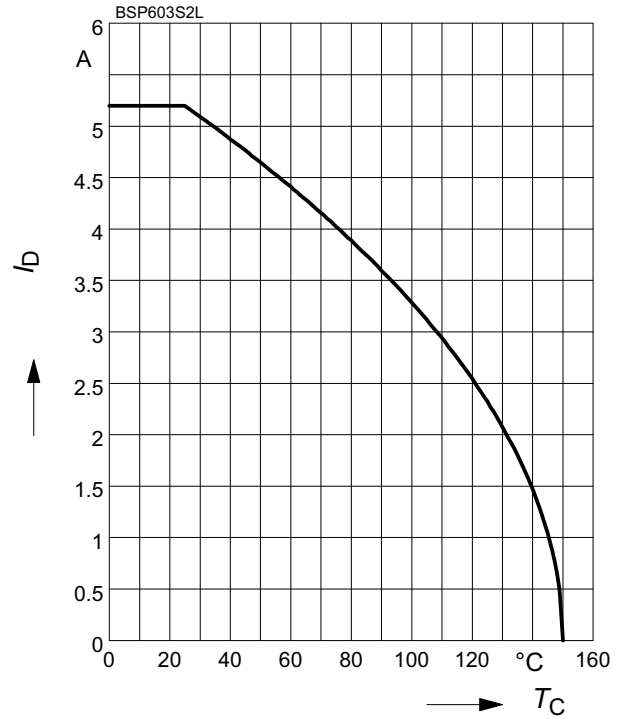
parameter: $V_{GS} \geq 4 \text{ V}$



2 Drain current

$$I_D = f(T_C)$$

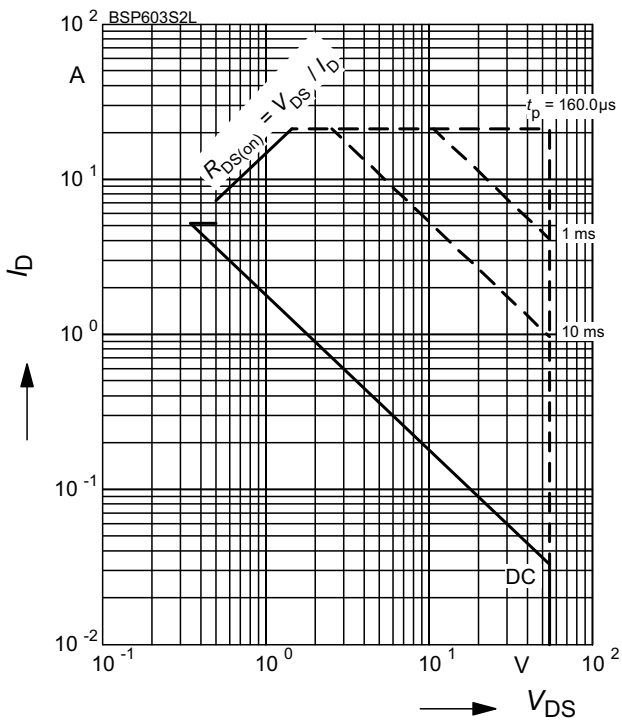
parameter: $V_{GS} \geq 10 \text{ V}$



3 Safe operating area

$$I_D = f(V_{DS})$$

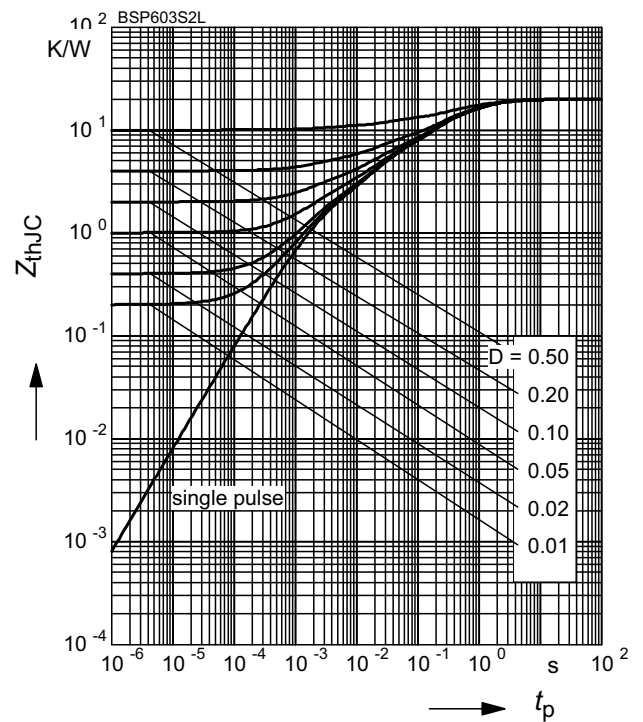
parameter: $D = 0, T_C = \text{--}$



4 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$

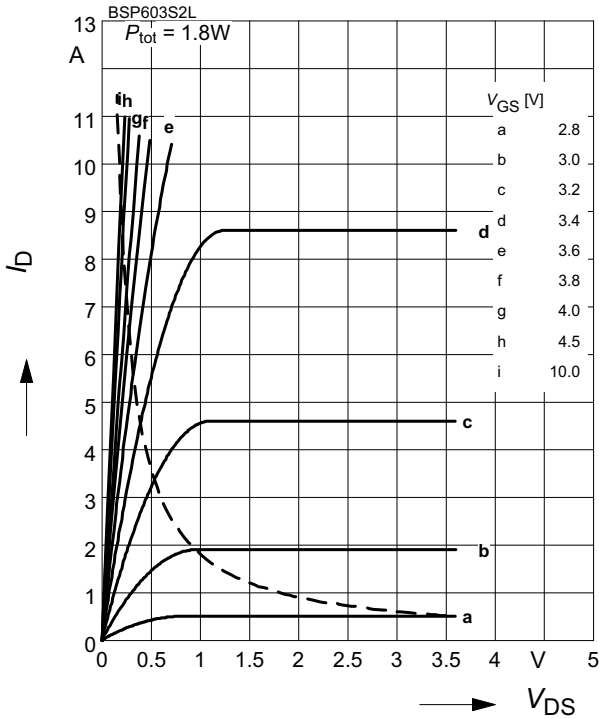
parameter: $D = t_p/T$



5 Typ. output characteristic

$I_D = f(V_{DS}); T_j = 25^\circ\text{C}$

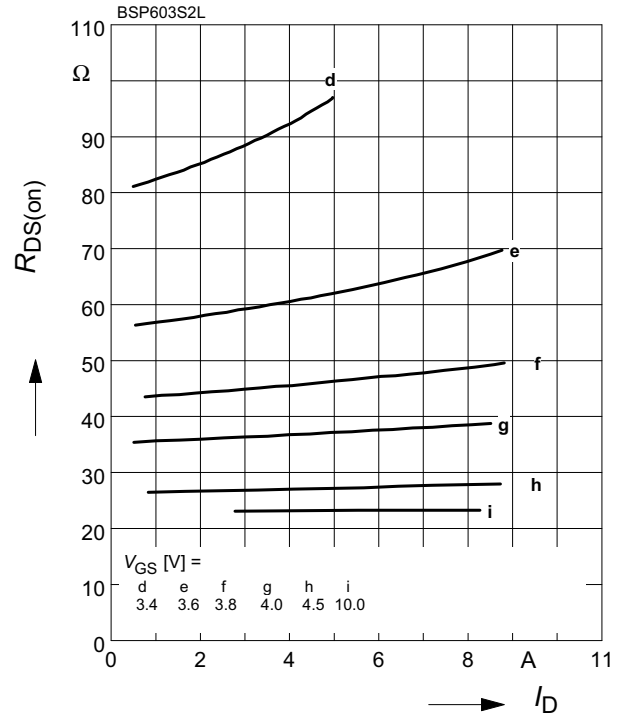
parameter: $t_p = 80 \mu\text{s}$



6 Typ. drain-source on resistance

$R_{DS(on)} = f(I_D)$

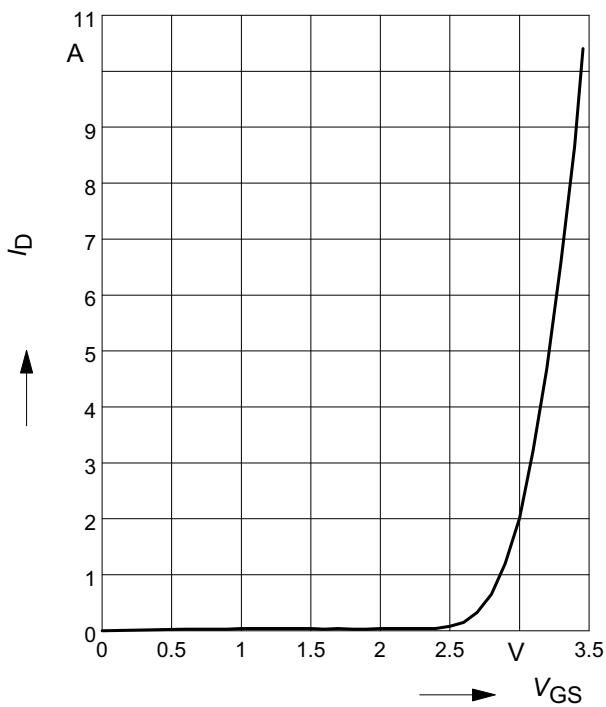
parameter: V_{GS}



7 Typ. transfer characteristics

$I_D = f(V_{GS}); V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$

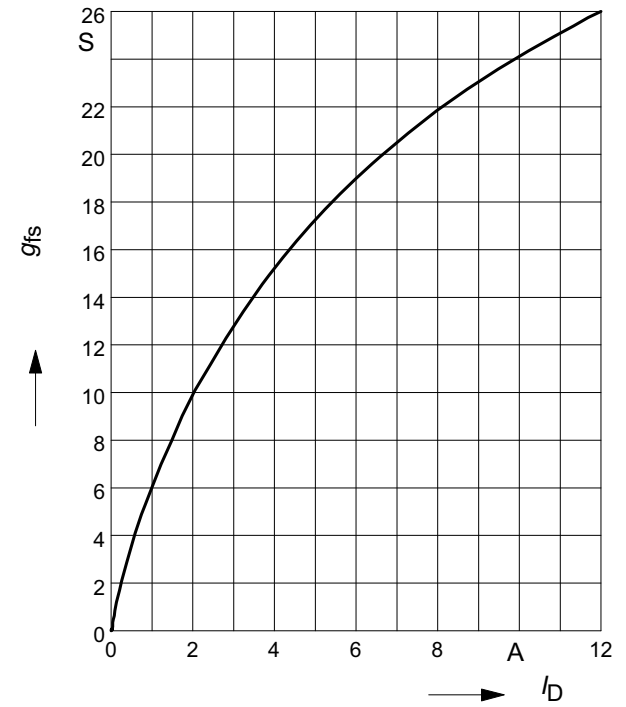
parameter: $t_p = 80 \mu\text{s}$



8 Typ. forward transconductance

$g_{fs} = f(I_D); T_j = 25^\circ\text{C}$

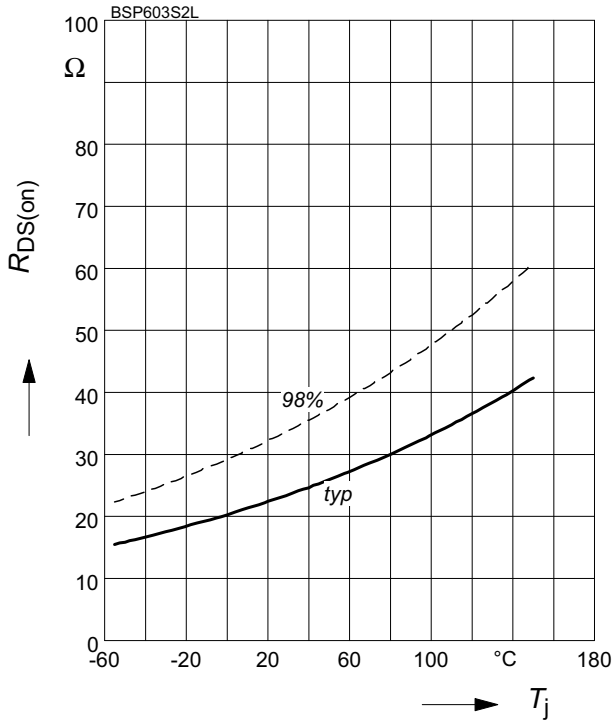
parameter: g_{fs}



9 Drain-source on-state resistance

$$R_{DS(on)} = f(T_j)$$

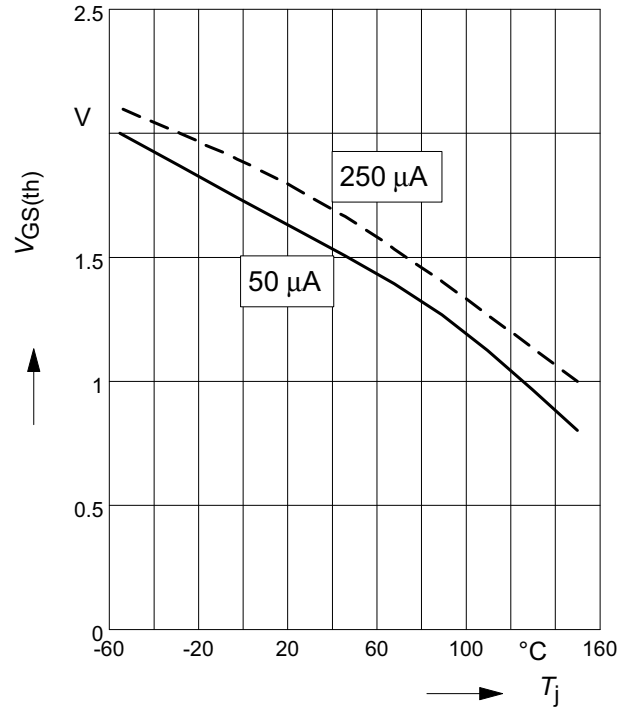
parameter : $I_D = 2.6 \text{ A}$, $V_{GS} = 10 \text{ V}$



10 Typ. gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

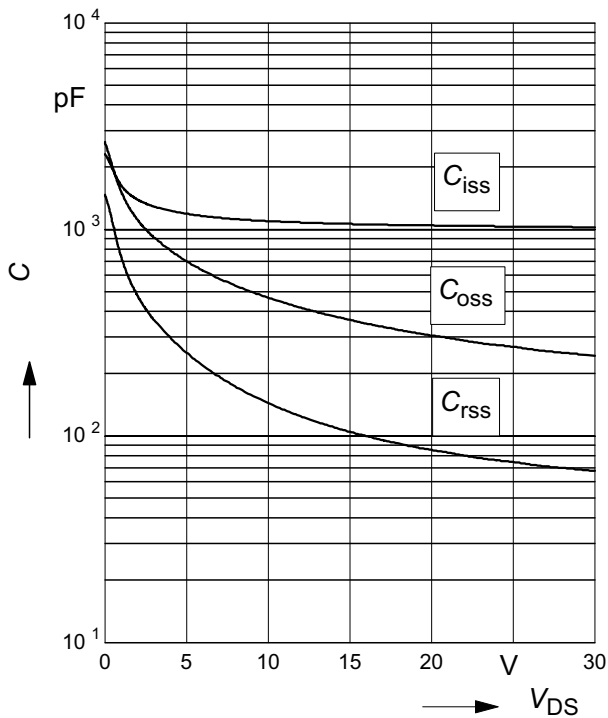
parameter: $V_{GS} = V_{DS}$



11 Typ. capacitances

$$C = f(V_{DS})$$

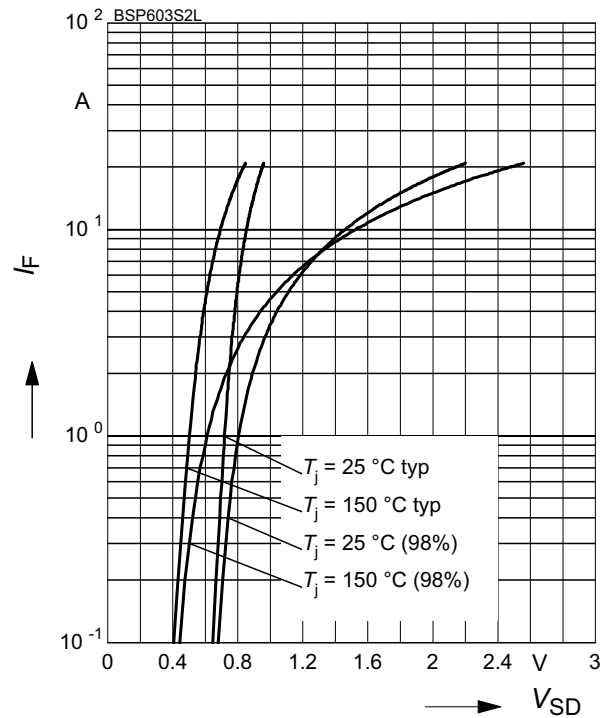
parameter: $V_{GS}=0\text{V}$, $f=1 \text{ MHz}$



12 Forward character. of reverse diode

$$I_F = f(V_{SD})$$

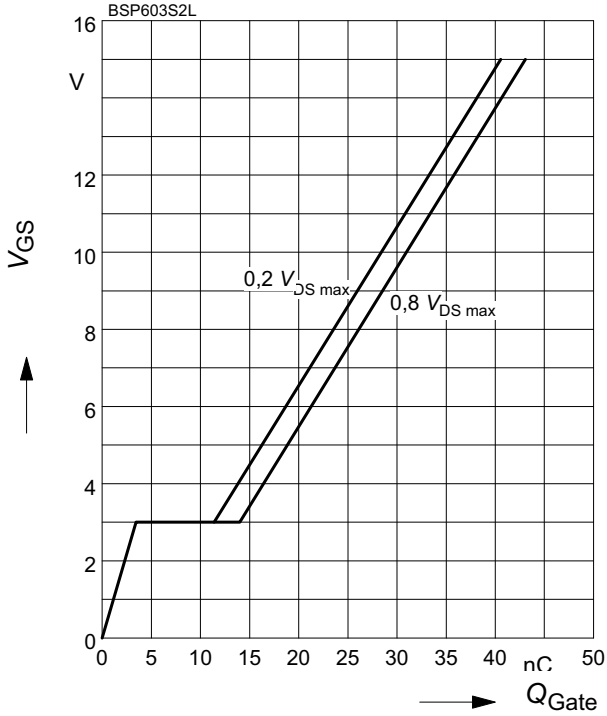
parameter: T_j , $t_p = 80 \mu\text{s}$



13 Typ. gate charge

$$V_{GS} = f(Q_{Gate})$$

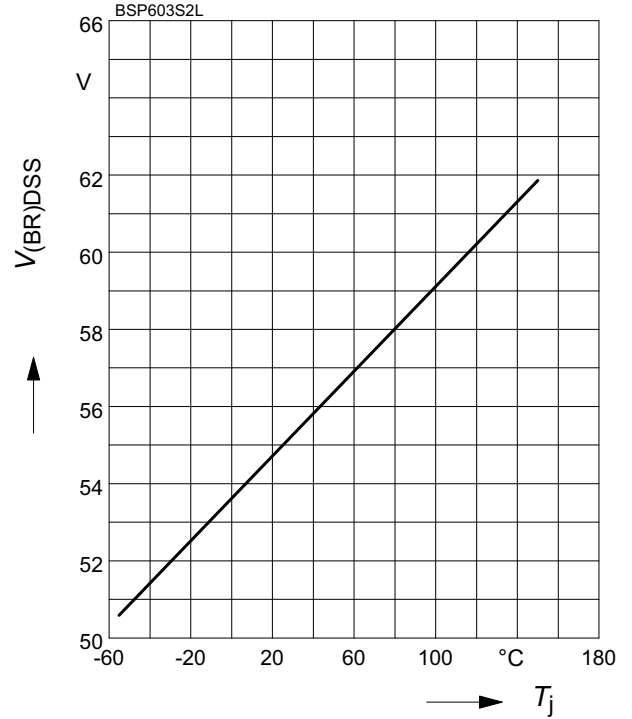
parameter: $I_D = 5.2 \text{ A pulsed}$



14 Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$

parameter: $I_D = 10 \text{ mA}$



1 Package Outlines

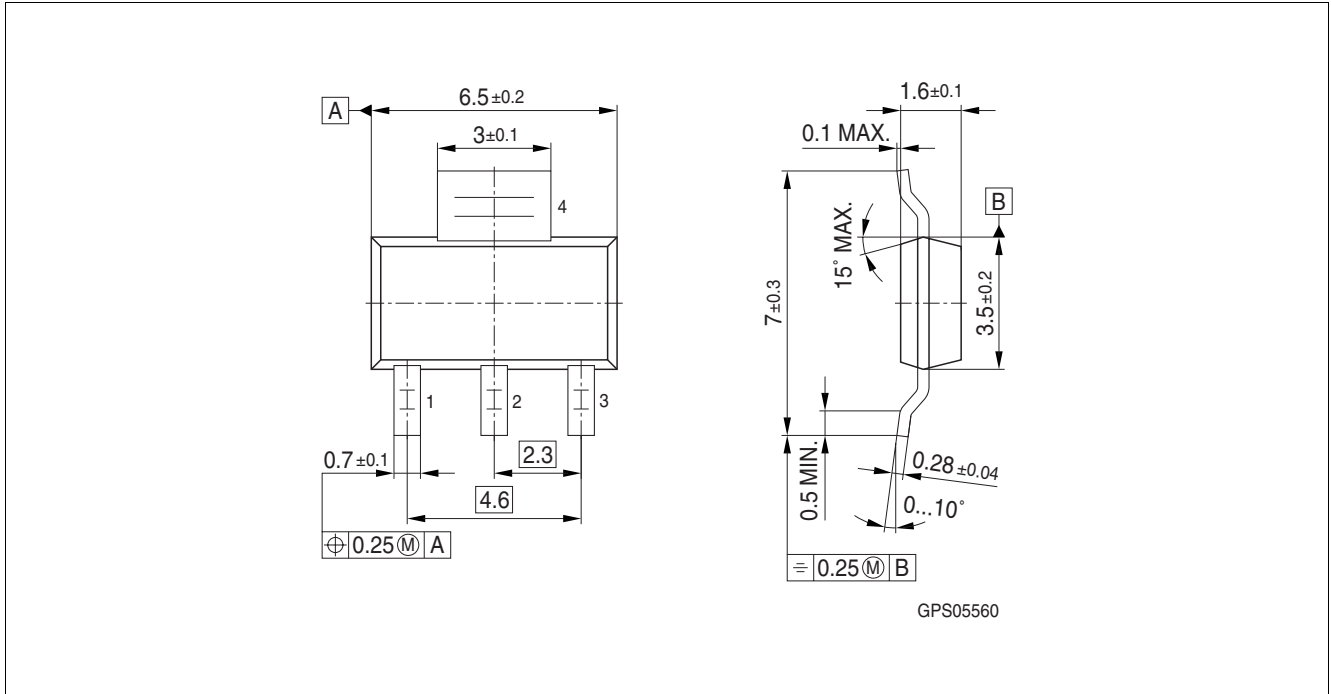


Figure 1 SOT 223

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e. Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on alternative packages, please visit our website:
<http://www.infineon.com/packages>.

Dimensions in mm

2 Revision History

Revision	Date	Changes
1.1	2008-05-27	Initial version of RoHS-compliant derivate of BSP603S2L Page 1: AEC certified statement added Page 1 and 8: added RoHS compliance statement and Green product feature Page 1 and 8: Package changed to RoHS compliant version Page 9-10: added Revision History, updated Legal Disclaimer

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[SSM6P69NU,LF](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#)